## Record of Letter Ballot Review by TC Chapter for Procedural Review

Region/Locale: North America Global Technical Committee: 3DS-IC TC Chapter Cochairs: Richard Allen/NIST, Chris Moore/Frontier Semiconductor, Sesh Ramaswami/Applied Materials Standards Staff: Laura Nguyen

	Scheduled in Background Statement	Actual
Date	07/12/2017	07/12/2017
Location	San Francisco, CA	San Francisco, CA
Reason for Change of Date and/or Location (if changed)		

Note: See *Regulations* ¶ 9.5 Exception for allowable reason to change.

#### I. Document Number and Title

<b>Document Number</b>	Document Title
6179	Reapproval of SEMI 3D1-0912, Terminology for
	Through Silicon via Geometrical Metrology

## II. Tally

Standards staff to fill in.

Voting Tally: As-cast tally after close of voting period

Note: A minimum of 60% of the Voting Interests that have TC Members within the global technical committee that issued the Letter Ballot must return Votes. (*Regulations* ¶ 9.7.1.1)

#### Voting Tally (with example values):

Voting Interest:	<b>Returned Votes</b>		Distribution		Return Rate	
Letter Ballot	41	÷	62	=	66.1%	≥60%
Intercommittee Ballot	34	]				
Voting Interest Reject(s)	0	]	Total	Vote	rs with Rejects	0
Voting Interest Accept(s)	35	]				

Note: See Regulations § 3.2.1 for definition of Voting Interest.

III. Rejects None

#### IV. Other Technical Issues None

# V. Comments V- (i) Voters' Comments

Commenter 1 (Tsukasa Fukunaga/Entegris) - Comment 1

Comment	Refering Wikipedia (in 5.9.3) may not suitable for SEMI Standard since anyone can modify Wikipedia pages. Others seems acceptable.						
	The	e TC Chapter agreed to do one of the following actions.					
	*No	motion is required in this step.					
		Already addressed by Commenter #, Comment #					
Action	x	No further action was taken by the TC Chapter. TC Chapter decided to approve ballot as written. Will revisit this in a future revision ballot.					
'n	x	Refer to the TF for more consideration. TF Suggested alternate wording: Replace "Wikipedia indicates that" with "Commonly use of"					
		New Business					
		Editorial Change					

#### Commenter 2 (Haruo Shimamoto/AIST) - Comment 1

Comment	Need to add the definition of side wall oxide thickness.						
	The	e TC Chapter agreed to do one of the following actions.					
	*No	motion is required in this step.					
		Already addressed by Commenter #, Comment #					
Action	x	No further action was taken by the TC Chapter. TC Chapter decided to approve ballot as written. Will revisit this in a future revision ballot.					
on	x	Refer to the TF for more consideration. TF suggests asking the commenter for a draft definition. Such a definition could be included in a future revision of the document, possibly with a SNARF for the Fall 2017 meetings.					
		New Business					
		Editorial Change					

# V-(ii) Comments Created by Handling Negative None

## VI. Editorial Changes Other than Those Voted on in § V None

#### VII. Approval Conditions Check VII. - (i). Approval Rate

APPROVAL CONDITION 1: All Negatives have been discussed and were withdrawn, found not related, found not persuasive, or addressed by a technical change. (*Regulations* ¶ 9.7.1.2)

APPROVAL CONDITION 2: At least 90% of the sum of valid Voting Interest Accept and Voting Interest Reject Votes must be Accept. (*Regulations* ¶ 9.7.1.3)

Note: If both approval conditions are not satisfied, the Document fails.

		Accepts		(Accepts + Valid Rejects)			
Approval Rate	=	35	/	35	=	100.0%	≥90%

#### VII. – (ii) Approval Level (check one)

Note: See Regulations § 9.7.2 for further information.

Globally Approved (No Ratification Ballot needed): The Letter Ballot meets the Letter Ballot approval conditions for the global technical committee.

Need a Ratification Ballot:

The Letter Ballot meets the Letter Ballot approval conditions for the TC Chapter and a Ratification Ballot will be issued to validate technical changes.

## VIII. Safety Check

Χ

#### Note: See Regulations § 15 for further information.

	x	Th is s	This is not a Safety Document, when all safety-related information is removed, the Document is still technically sound and complete. ( <i>Regulations</i> $\P$ 8.7.1)						
Motior				ty <b>Document</b> , when all safety-related information is removed, the Document is not nd and complete. ( <i>Regulations</i> $\P$ 8.7.2)					
ſ		Safety Checklist ( <i>Regulations</i> ¶ 15.3) is complete and has been included with the Document throughout the balloting process. ( <i>Regulations</i> ¶ 15.1.2)							
I	Noti	ion l	oy/2 <sup>nd</sup> by	Bevan Wu (BW & Associates/ITRI) / Vern Solberg (Solberg Technical Consulting)					
Discussion				None					
	Vote 8 Y 0 N; Motion passed.								

# IX. Intellectual Property (IP) Check

Note: This Letter Ballot may cover all or part of a Standard or Safety Guideline. This IP check applies to the entire Standard or Safety Guideline. See *Regulations* § 16 for further information.

x	The TC Chapter meeting chair asked those participating, if they were aware of any potentially material patented technology or copyrighted items* in the Standard or Guideline. ( <i>Regulations</i> ¶ 8.8.1)				
	x No potentially material patented technology or reproduction of copyrighted items is known. GC		GO TO SECTION X.		

\* Note: Such potentially material patented technology or copyrighted items might have become known since the Standard or Safety Guideline was last reviewed, or might become relevant due to this Letter Ballot.

# X. Action for This Document

Motion	x		ment passed TC Chapter review as balloted and will be forwarded to the ISC A&R cedural review.			
Г		on by/ <sup>d</sup> by	Vern Solberg (Solberg Technical Consulting) / Steve Martell (Sonoscan)			
C	Disc	ussion	None			
Vote			8 Y 0 N			
F	inal	Action	X Motion passed			
	mai	AUGUI	Motion failed			

#### Standards staff to record the result of the A&R procedural review here:

A&R		Approved for publication
		Approved pending acceptance of the Ratification Ballot
		Not approved
	Re	eason: